

Special Issue

2D Materials and Their Applications in Electronic and Optoelectronic Devices, and Sensors

Message from the Guest Editor

The focus of this Special Issue is the fundamental study and novel applications of 2D materials that may pave the path to the next generation of electronics, optoelectronics, and sensors, as well as the recent advances in the growth and production of 2D materials.

Scope:

- *Large-area growth and characterization of 2D materials*
- *Novel 2D material-based electronics, optoelectronics, sensors, wearables, super capacitors, and energy storage devices*
- *Theoretical and fundamental study of 2D materials*

Guest Editor

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Deadline for manuscript submissions

closed (31 May 2021)



Micromachines

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Impact Factor 3.0
CiteScore 6.0
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mdpi.com/si/67385

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Message from the Editor-in-Chief

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